Chip Beads

MPZ2012S601AT000

Applications	Commercial Grade
Feature	Power Line
Series	MPZ Series / MPZ2012 Type
Status	Production



Size		
Length(L)	2.00mm +/-0.20mm	
Width(W)	1.25mm +/-0.20mm	
Thickness(T)	0.85mm +/-0.20mm	
Recommended Land Pattern (A)	0.80mm Nom.	
Recommended Land Pattern (B)	1.00mm Nom.	
Recommended Land Pattern (C)	1.20mm Nom.	

Electrical Characteristics			
Impedance at 100MHz	600Ω +/-25%		
Rated Current	2A		
DC Resistance [Max.]	100mΩ		

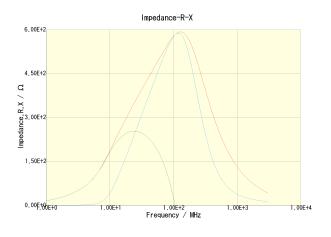
Other			
Operating Temp. Range (Including Self-Temp. Rise)	-55 to 125degC		
Soldering Method	Reflow, Iron Soldering		
AEC Q200	No		
Packing	Punched (Paper)Taping [180mm Reel]		
Package Quantity	4000Pcs Min.		
Weight	0.008g		

•This PDF document was created based on the data listed on the TDK Corporation website.

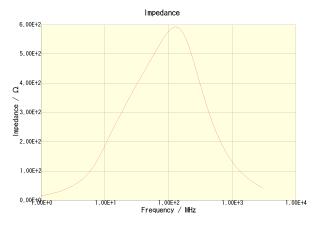
•All specifications are subject to change without notice.

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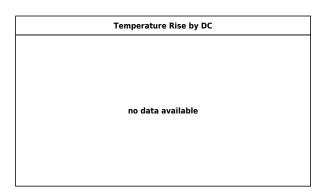
Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)

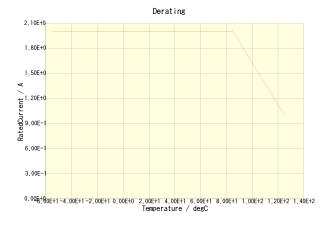


MPZ2012S601AT000(|Z|)PZ2012S601AT000(R)MPZ2012S601AT000(X)



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